# onsemi

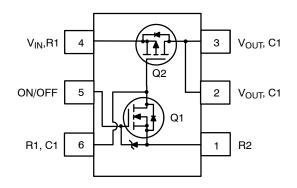
## Integrated Load Switch FDC6324L

#### Description

These Integrated Load Switches are produced using **onsemi**'s proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on–state resistance and provide superior switching performance. These devices are particularly suited for low voltage high side load switch application where low conduction loss and ease of driving are needed.

#### Features

- $V_{DROP} = 0.2 \text{ V} @ V_{IN} = 12 \text{ V}, I_L = 1 \text{ A}, V_{ON/OFF} = 1.5 \text{ to } 8 \text{ V}$
- $V_{DROP} = 0.3 \text{ V} @ V_{IN} = 5 \text{ V}, I_L = 1 \text{ A}, V_{ON/OFF} = 1.5 \text{ to } 8 \text{ V}$
- High Density Cell Design for Extremely Low On-Resistance
- V<sub>ON/OFF</sub> Zener Protection for ESD Ruggedness > 6 kV Human Body Model
- SUPERSOT<sup>™</sup>-6 Package Design Using Copper Lead Frame for Superior Thermal and Electrical Capabilities
- This is a Pb–Free and Halide Free Device





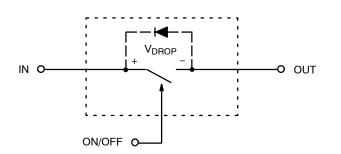


Figure 2. Equivalent Circuit



TSOT-23-6 CASE 419BL

### MARKING DIAGRAM



= Designates Space

- = Binary Calendar Year Coding Scheme
- = Pin One Dot

&Е

&Y

&.

&G

324 = Specific Device Code

= Date Code

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
FDC6324L	TSOT-23-6 (Pb-Free)	3000 / Tape & Reel

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### ABSOLUTE MAXIMUM RATINGS T<sub>A</sub> = 25°C unless otherwise noted

Symbol	ymbol Parameter		Unit	
V <sub>IN</sub>	Input Voltage Range	3–20	V	
V <sub>ON/OFF</sub>	On/Off Voltage Range	1.5–8	V	
ار	Load Current @ V <sub>DROP</sub> = 0.5 V – Continuous (Note 1)	1.5	А	
	Load Current @ V <sub>DROP</sub> = 0.5 V - Pulsed (Note 1, Note 3)	2.5		
PD	Maximum Power Dissipation (Note 2a)	0.7	W	
T <sub>J</sub> , T <sub>STG</sub>	T <sub>J</sub> , T <sub>STG</sub> Operating and Storage Temperature Range		°C	
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100 pF/1500 $\Omega$ )	6	kV	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **THERMAL CHARACTERISTICS** $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 2a)	180	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 2)	60	°C/W

#### ELECTRICAL CHARACTERISTICS T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit	
OFF CHARACTERISTICS							
I <sub>FL</sub>	Forward Leakage Current	$V_{IN}$ = 20 V, $V_{ON/OFF}$ = 0 V	-	-	1	μΑ	
I <sub>RL</sub>	Reverse Leakage Current	$V_{IN} = -20$ V, $V_{ON/OFF} = 0$ V	-	-	-1	μA	

#### **ON CHARACTERISTICS** (Note 3)

V <sub>IN</sub>	Input Voltage			-	20	V
V <sub>ON/OFF</sub>	On/Off Voltage		1.5	-	8	V
V <sub>DROP</sub>	Conduction Voltage Drop @ 1 A	$V_{IN}$ = 10 V, $V_{ON/OFF}$ = 3.3 V	-	0.135	0.2	V
	Drop @ T A	$V_{IN}$ = 5 V, $V_{ON/OFF}$ = 3.3 V	-	0.215	0.3	
١L	Load Current	$V_{DROP}$ = 0.2 V, $V_{IN}$ = 10 V, $V_{ON/OFF}$ = 3.3 V	1	-	-	А
		$V_{DROP}$ = 0.3 V, $V_{IN}$ = 5 V, $V_{ON/OFF}$ = 3.3 V	1	-	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTES:

- V<sub>IN</sub> = 20 V, V<sub>ON/OFF</sub> = 8 V, V<sub>DROP</sub> = 0.5 V, T<sub>A</sub> = 25°C
  R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

 $P_{D}(t) = \frac{T_{J} - T_{A}}{R_{\theta JA}(t)} = \frac{T_{J} - T_{A}}{R_{\theta JC} + R_{\theta CA}(t)} = I_{D}^{2}(t) \times RDS(ON)@T_{J}$ Typical  $R_{\theta CA}$  for single device operation using the board layouts shown below on FR-4 PCB in a still air environment: 

a) 180°C/W when mounted on a 2oz

minimum copper pad. 111

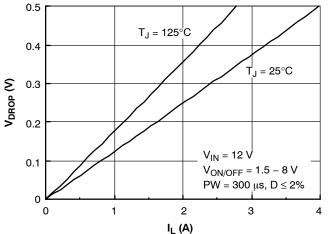
3. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2.0%.

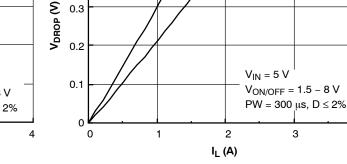
0.5

0.4

0.3

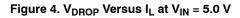
#### **TYPICAL ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)





T<sub>J</sub> = 125°C

Figure 3.  $V_{DROP}$  Versus I<sub>L</sub> at V<sub>IN</sub> = 12 V



3

4

T<sub>J</sub> = 25°C

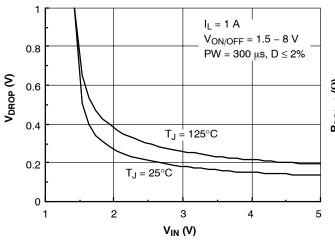


Figure 5.  $V_{DROP}$  Versus  $V_{IN}$  at  $I_L = 1$  A

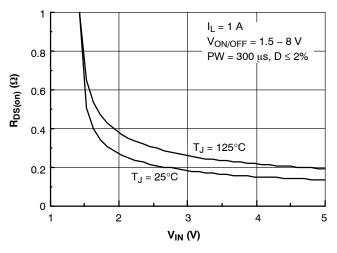


Figure 7. On Resistance Variation with **Input Voltage** 

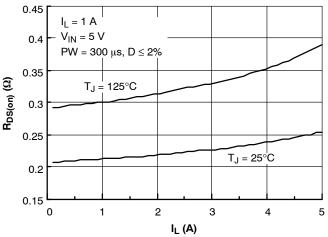


Figure 6. R<sub>DS(on)</sub> Versus I<sub>L</sub> at V<sub>IN</sub> = 5.0 V

#### TYPICAL ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

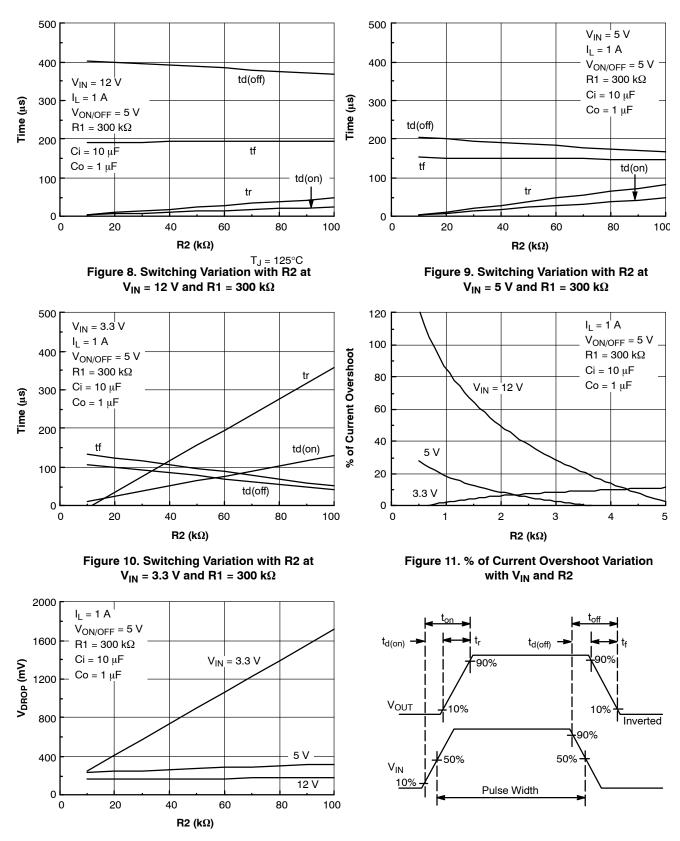


Figure 12. V<sub>DROP</sub> Variation with V<sub>IN</sub> and R2



TYPICAL ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

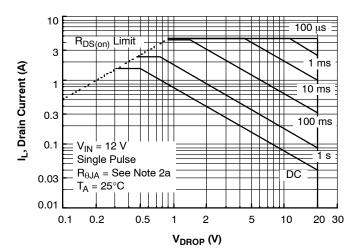
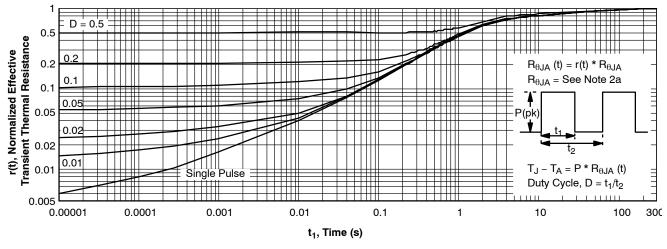
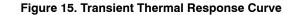


Figure 14. Safe Operating Area





NOTE: Thermal characterization performed on the conditions described in Note 2a. Transient thermal response will change depends on the circuit board.

#### LOAD SWITCH APPLICATION

#### **General Description**

This device is particularly suited for computer peripheral switching applications where 20 V input and 1 A output current capability are needed. This load switch integrates a small N–Channel Power MOSFET (Q1) which drives a large P–Channel Power MOSFET (Q2) in one tiny SUPERSOT–6 package.

A load switch is usually configured for high side switching so that the load can be isolated from the active power source. A P–Channel Power MOSFET, because it does not require its drive voltage above the input voltage, is usually more cost effective than using an N–Channel device in this particular application. A large P–Channel Power MOSFET minimizes voltage drop. By using a small N–Channel device the driving stage is simplified.

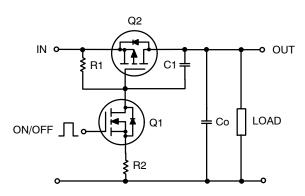


Figure 16. Application Circuit

#### • R1: Typical 10k-1 MΩ

**Component Values** 

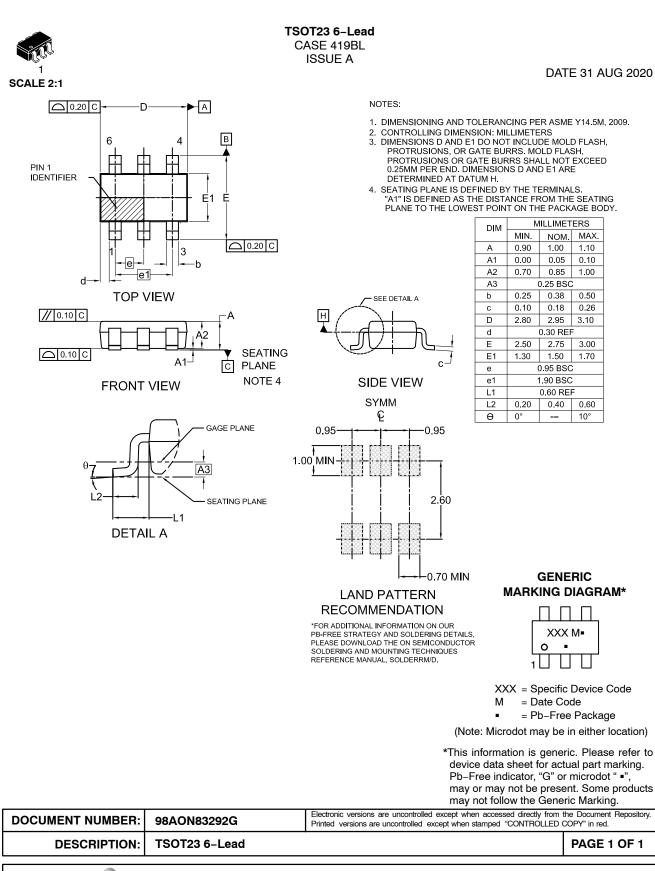
- R2: Typical  $0-100 \text{ k}\Omega$  (optional)
- C1: Typical 1000 pF (optional)

#### **Design Notes**

- R1 is needed to turn off Q2.
- R2 can be used to soft start the switch in case the output capacitance Co is small.
- R2 should be at least 10 times smaller than R1 to guarantee Q1 turns on.
- By using R1 and R2 a certain amount of current is lost from the input. This bias current loss is given by the equation:  $IBIAS\_LOSS = \frac{V_{IN}}{R1 + R2}$  when the switch is ON.  $I_{BIAS\_LOSS}$  can be minimized by selecting a large value for R1.
- R2 and C<sub>RSS</sub> of Q2 make ramp for slow turn on. If excessive overshoot current occurs due to fast turn on, additional capacitance C1 can be added externally to slow down the turn on.

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